4.2 Setting screens

To enter each setting screen, press [MAN.] key on the MAIN SCREEN. The setting screens are constructed shown below.

- [FWD PAGE] key:

- [REV PAGE] key:

- [AUTO] key:

Pressing the key displays "2nd page of the setting screen". Pressing the key displays "1st page of the setting screen".

Pressing the key displays MAIN SCREEN.

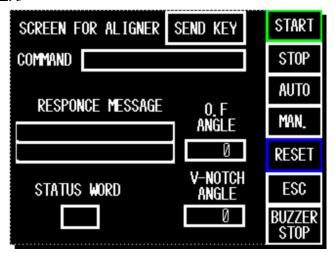
1st page of the setting screen

WAFER	CASS.	T/DATA	START
SIZE	MODE	., 5	ST0P
WAFER	LAMP	TOTAL	AUTO
TYPE	TIME	TIMER	MAN.
UV, N2 Select	T3 ALI. SELECT		RESET
		FLD.	ESC
		FWD Page	BUZZER STOP

2nd page of the setting screen

ALIGNER	3-TIMES	APPLY	START
NETUNEK	APPLY	DOWN	ST0P
T/1, 2 SELECT	T/3 SELECT	REPEEL	AUTO
SELEGI	9ELEG I	SELECT	MAN.
PAD UP TI ME R	TABLE Blow	IRRA., N2 Timer	RESET
			ESC
REV Page	TBL. PAD SELECT	ROB. VAC. SELECT	BUZZER STOP

ALIGNER <SCREEN FOR ALIGNER>



The screen is used to operation individually for maintenance of the aligner.

- [SEND KEY]: Pressing the key sends the entered command to the aligner.

- COMMAND: Input the command to operate the aligner.

Refer to 5.2 Manual operations for the aligner for further information.

- RESPONSE MESSAGE: Shows the details of "BYTE3" of the status word.

- STATUS WORD: Shows the current status of the aligner with signal of 4-digit.
- O.F ANGLE: Shows the OF wafer angle after the alignment has finished.
- V-NOTCH ANGLE: Shows the Notch wafer angle after the alignment has finished.

<Setting method>

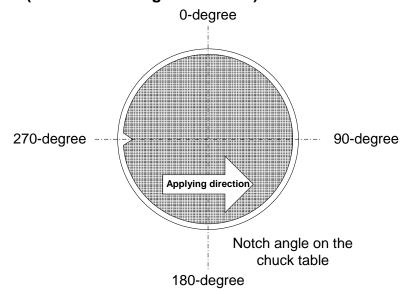
- (1) Press the display of "COMMAND". The keyboard is indicated.
- (2) Enter the number and press [ENT] key. The value is input.

*Refer to 4-2-5 for the detail of the command.

- [ESC] key: Pressing the key displays "2nd page of the setting screen".

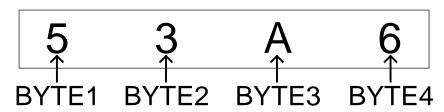
- [AUTO] key: Pressing the key displays MAIN SCREEN.

Input value = $5725 - (6000 / 360 \times the angle on the table)$



Display of "STATUS WORD"

STATUS WORD



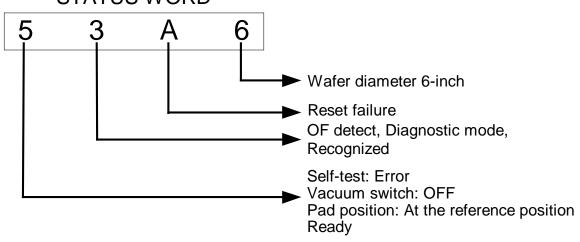
Details of BYTE1				
	Self-test	Vacuum switch	Pad position	Ready / Operating
0	OK	OFF	Not at the reference position	Ready
1	Error	OFF	Ditto	Ditto
2	OK	ON	Ditto	Ditto
3	Error	ON	Ditto	Ditto
4	OK	OFF	At the reference position	Ditto
5	Error	OFF	Ditto	Ditto
6	OK	ON	Ditto	Ditto
7	Error	ON	Ditto	Ditto
8	OK	OFF	Not at the reference position	Operating
9	Error	OFF	Ditto	Ditto
Α	OK	ON	Ditto	Ditto
В	Error	ON	Ditto	Ditto
С	OK	OFF	At the reference position	Ditto
D	Error	OFF	Ditto	Ditto
Е	OK	ON	Ditto	Ditto
F	Error	ON	Ditto	Ditto

Details of BYTE2			
	Detect mode	Recognize the command	
0	Notch detect	Recognized	
1	OF detect	Ditto	
2	Notch detect	Ditto	
3	OF detect	Ditto	
4	Notch detect	Not recognized	
5	OF detect	Ditto	
6	Notch detect	Ditto	
7	OF detect	Ditto	

Details of BYTE3				
0	No error			
1	CCD reading error			
2	CCD out of the range			
3	-			
4	-			
5	Motor board time out			
6	-			
7	-			
8	Vacuum sensor error			
9	-			
Α	Aligner data error			
В	Aligner X-axis reset error			
С	Aligner Y-axis reset error			
	The detail of BYTE4			
3	Wafer diameter 3-inch			
4	Wafer diameter 4-inch			
5	Wafer diameter 5-inch			
6	Wafer diameter 6-inch			
8	Wafer diameter 8-inch			

<Example>

STATUS WORD



Command type:

BW: Switches to the alignment operation for T3. Only the wafer centering is

performed without V-notch detection.

FW <offset>: Aligns the wafer at an offset angle you input.

(The offset angle is 0-degree if the value is not input)

GW: The offset angle ("SR" command) is read from the battery backup RAM, and

aligns the wafer.

RC: The vacuum pad is moved to the reference position.

RS: Reset the aligner.

RX <step>: Moves X-axis direction by an increment of the step. RY <step>: Moves Y-axis direction by an increment of the step.

RW <step>: Turns the pad by an increment of the step.

SF: Sets the OF detect mode.
SN: Sets the Notch detect mode.

SR<Offset>: It is used with GW command. Inputs the previous offset angle to the battery

backup RAM.

SX: Change the CCD unit size. (Enter the wafer size to "X")

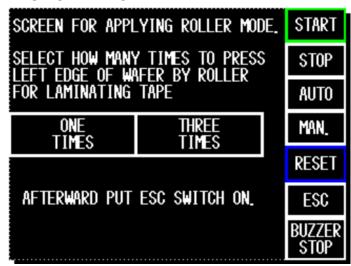
VN: Turns on vacuum. VF: Turns off vacuum.

CCD correction

CB: Corrects the CCD

^{*} Described "Command <step / setting value>" is requires to input the value in <> when you input the value.

3-TIMES APPLY <SCREEN FOR APPLYING ROLLER MODE>



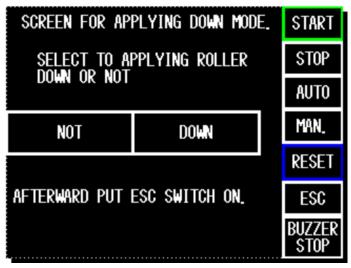
You can select the applying roller mode to peel the BG tape easier on the screen. The applying roller pressures the wafer left edge 1 or 3 times.

The selected item lights up green.

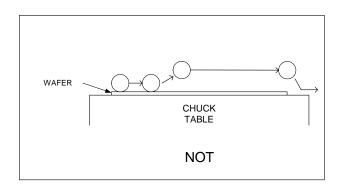
- [ESC] key: Pressing the key displays "2nd page of the setting screen".

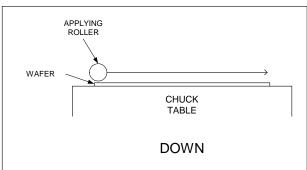
- [AUTO] key: Pressing the key displays MAIN SCREEN.

APPLY DOWN <SCREEN FOR APPLYING DOWN MODE>



You can select the applying roller movement shown below figure. The selected item lights up green.





- [ESC] key: Pressing the key displays "2nd page of the setting screen".
- [AUTO] key: Pressing the key displays MAIN SCREEN.

T/1, 2 SELECT WIND TIME <SCREEN FOR WINDING, WIND START SETTING>



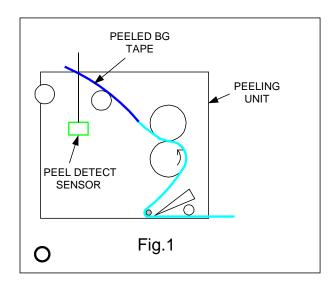
The setting screens for T1, T2 are different from T3.

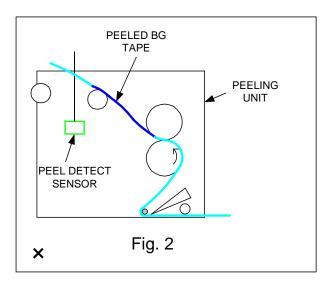
You can set the peeling tape winding time and wind start time for T1 and T2.

WIND: The timer to send the peeled tape to the detect position of the peel detect sensor. (Fig. 1)
 (The time the peeling roller (lower) tums after the peeling unit has reached the right end
 peeling the BG tape)

The sensor cannot detect whether the BG tape peeled correctly or not if "WIND" is not appropriate. (Fig. 2)

In case of the fig. 2, the machine judges the BG tape has not peeled and error occurs.





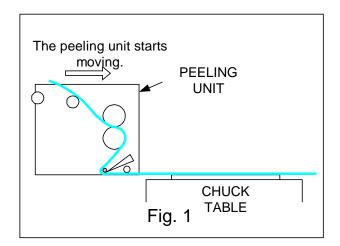
- WIND START: The time that after the peeling unit starts moving to the arrow direction (Fig. 1) until

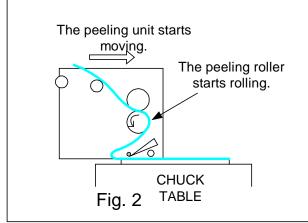
the peeling roller (Lower) starts turning.

Input "0" in general use.

If other values are input to "WIND START", the BG tape has sag on the left side of

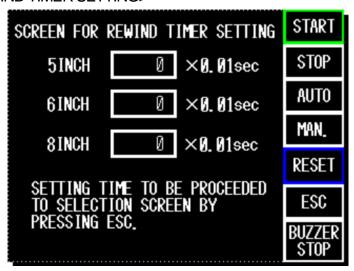
the extension roller as shown Fig.2.





- (1) Press the numeric display part. The keyboard is indicated.
- (2) Enter the value and press [ENT] key. The value is input.
- [ESC] key: Pressing the key displays "T/1, 2 SELECT SCREEN".
- [AUTO] key: Pressing the key displays MAIN SCREEN.

T/1, 2 SELECT
REWIND TIME
<SCREEN FOR REWIND TIMER SETTING>

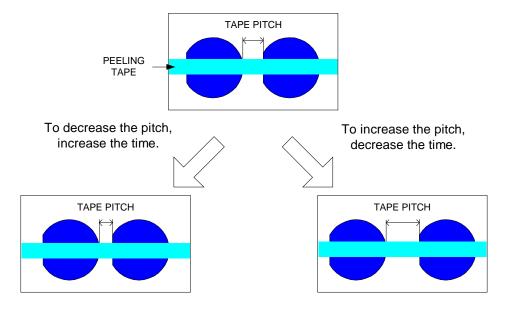


The setting screens for T1, T2 are different from T3.

You can set the timer to adjust the tape pitch on the screen for T1 and T2.

REWIND TIMER is the time to that the peeling roller (Lower) turns clockwise to rewind the tape at the process the peeling unit moves left from the right end.

Adjust the value the tape pitch is 30 + / - 10mm.



- (1) Press the numeric display part. The keyboard is indicated.
- (2) Enter the value and press [ENT] key. The value is input.
- [ESC] key: Pressing the key displays "T/1, 2 SELECT SCREEN".
- [AUTO] key: Pressing the key displays MAIN SCREEN.

T/3 SELECT WIND TIME <SCREEN FOR T/3 WINDING SETTING>



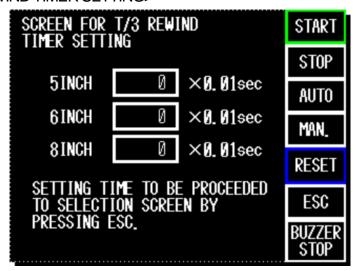
The setting screens for T1, T2 are different from T3.

You can set the peeling tape winding time and wind start time for T3.

Refer to the T/1, 2 SELECT for more information.

- (1) Press the numeric display part. The keyboard is indicated.
- (2) Enter the value and press [ENT] key. The value is input.
- [ESC] key: Pressing the key displays "T/3 SELECT SCREEN".
- [AUTO] key: Pressing the key displays MAIN SCREEN.

T/3 SELECT
REWIND TIME
<SCREEN FOR T/3 WIND TIMER SETTING>



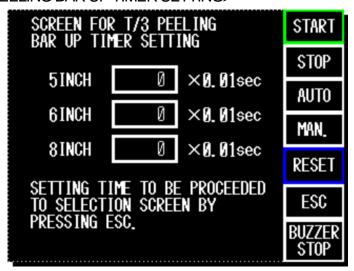
The setting screens for T1, T2 are different from T3.

You can set the timer to adjust the tape pitch on the screen for T3.

Refer to the T/1, 2 SELECT for more information.

- (1) Press the numeric display part. The keyboard is indicated.
- (2) Enter the value and press [ENT] key. The value is input.
- [ESC] key: Pressing the key displays "T/3 SELECT SCREEN".
- [AUTO] key: Pressing the key displays MAIN SCREEN.

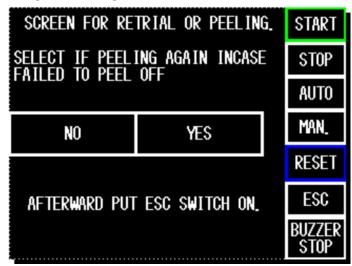
T/3 SELECT
PEELING BAR UP TIME
<SCREEN FOR T/3 PEELING BAR UP TIMER SETTING>



You can set the timer to up the peeling bar for T3.

- (1) Press the numeric display part. The keyboard is indicated.
- (2) Enter the value and press [ENT] key. The value is input.
- [ESC] key: Pressing the key displays "T/3 SELECT SCREEN".
- [AUTO] key: Pressing the key displays MAIN SCREEN.

REPEEL SELECT <SCREEN FOR RETRIAL OR PEELING>



You can select retrial function on the screen. When peeling movement is failed, the machine tries the movement again.

- NO: The machine stops when the peeling movement is failed.

- YES: The machine stops after the peeling movement failed total 3 times.

- [ESC] key: Pressing the key displays "2nd page of the setting screen".

- [AUTO] key: Pressing the key displays MAIN SCREEN.

PAD UP TIMER <SCREEN FOR PAD UP TIMER SETTING>



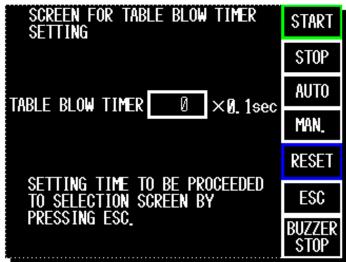
You can set the pad up timer for the chuck table.

After the BG tape peeling has completed, the vacuum is turned off, and the table pad moves up to enable getting the wafer with robot arm. When the table pad moves up, the wafer could damage by wafer linking.

To prevent from the damage, set the time from turning off the vacuum to the table pad moving up.

- (1) Press the numeric display part. The keyboard is indicated.
- (2) Enter the value and press [ENT] key. The value is input.
- [ESC] key: Pressing the key displays "2nd page of the setting screen".
- [AUTO] key: Pressing the key displays MAIN SCREEN.

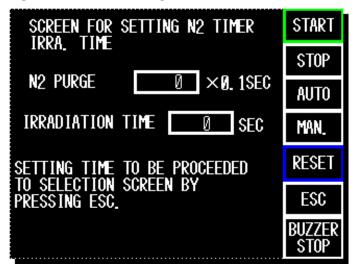
TABLE BLOW <SCREEN FOR TABLE BLOW TIMER SETTING>



The wafer may have damaged by wafer linking with the wafer table after DC tape applying has completed. The wafer table blow function prevents the wafer from damages.

- (1) Press the numeric display part. The keyboard is indicated.
- (2) Enter the value and press [ENT] key. The value is input.
- [ESC] key: Pressing the key displays "1st page of the setting screen".
- [AUTO] key: Pressing the key displays MAIN SCREEN.

IRRA, N2 TIMER <SCREEN FOR SETTING N2 TIMER IRRA. MODE>



You can set the purge time of N_2 and UV irradiation time on the screen.

- (1) Press the numeric display part. The keyboard is indicated.
- (2) Enter the value and press [ENT] key. The value is input.
- [ESC] key: Pressing the key displays "2nd page of the setting screen".
- [AUTO] key: Pressing the key displays MAIN SCREEN.

TBL. PAD SELECT <SCREEN FOR TABLE PAD UP TIMING SETTING>



- BEFORE: After the table pad has moved up, robot arm moves to put the wafer on the table pad.
- AFTER: After the robot arm has moved above the wafer chuck table, the table pad moves up.

- (1) Press the numeric display part. The keyboard is indicated.
- (2) Enter the value and press [ENT] key. The value is input.
- [ESC] key: Pressing the key displays "2nd page of the setting screen".
- [AUTO] key: Pressing the key displays MAIN SCREEN.

ROB. VAC. SELECT

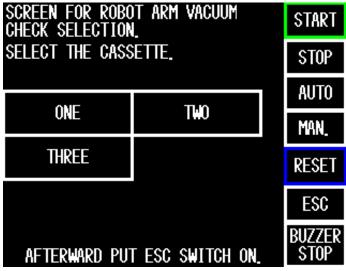
CASS. VAC.	ALI. VAC.	UV VAC.	S	TART
SELECT	SELECT	SELECT		STOP
TAB. VAC. SELECT				AUTO
SELEGI				MAN.
			R	ESET
2511				ESC
REV Page			В	UZZER Stop

The machine checks whether the wafer is vacuum chucked to robot arm correctly at each stage (Cassette, Aligner, UV, and Wafer chuck table).

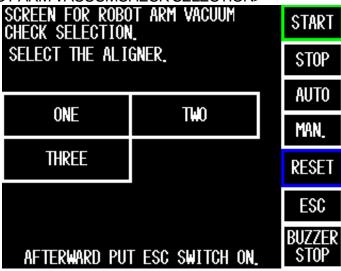
The robot arm has three holes for vacuum chucking.

Select how many holes are used to check wafer vacuum chucking status.

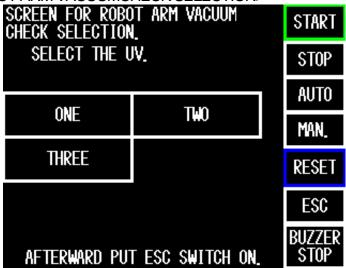
CASS. VAC. SELECT <SCREEN FOR ROBOT ARM VACUUMCHECK SELECTION>



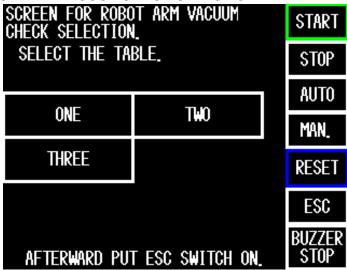
ALI. VAC. SELECT <SCREEN FOR ROBOT ARM VACUUMCHECK SELECTION>



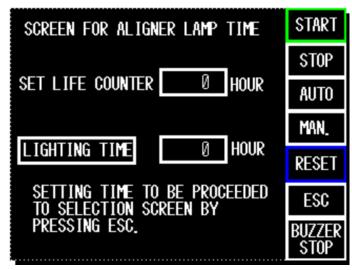
UV VAC. SELECT <SCREEN FOR ROBOT ARM VACUUMCHECK SELECTION>



TBL VAC. SELECT <SCREEN FOR ROBOT ARM VACUUMCHECK SELECTION>



LAMP TIME <SCREEN FOR ALIGNER LAMP TIME>



You can set the lifetime of the aligner lamp and confirm and reset the used hours of the aligner lamp after replacing the aligner lamp on the screen.

- SET LIFE COUNTER: Set the aligner lamps lifetime. The used hours of the aligner lamp reaches

the time, it is informed to the operators with buzzer and messages.

Recommended value: 1500 hours

The machine stops after the wafers in processing have been put into the

cassette.

- [LIGHTING TIME]: Shows the used hours of the aligner lamp after replacing the aligner lamp.

Pressing [LIGHTING TIME] resets the used hours.

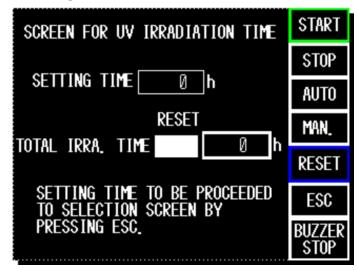
<Setting method>

- (1) Press the numeric display part. The keyboard is indicated.
- (2) Enter the value and press [ENT] key. The value is input.

- [ESC] key: Pressing the key displays "1st page of the setting screen".

- [AUTO] key: Pressing the key displays MAIN SCREEN.

TOTAL TIMER <SCREEN FOR UV IRRADIATION TIME>



You can set the lifetime of the UV lamp, and confirm and reset the used hours of the UV lamp after replacing the UV lamp on the screen.

- SETTING TIME: Set the UV lamps lifetime. The used hours of the UV lamp reaches the

time, it is informed to the operators with buzzer and messages.

Recommended value: 1000 hours

The machine stops after the wafers in processing have been put into the

cassette.

- TOTAL IRRA. TIME: Shows the used hours of the UV lamp after replacing the UV lamp.

Pressing [LIGHTING TIME] resets the used hours.

<Setting method>

- (1) Press the numeric display part. The keyboard is indicated.
- (2) Enter the value and press [ENT] key. The value is input.

- [ESC] key: Pressing the key displays "1st page of the setting screen".

- [AUTO] key: Pressing the key displays MAIN SCREEN.